

**Current Sensing Metal Chip Resistor**

**■ Features**

- SMD Type designed for automatic insertion (CSM02 : The soldering side has a black mark on the product surface .)
- High power rating in small size
- Low resistance resistor for current detection
- Metal foil construction ensures high reliability and performance with very low and stable TCR
- Designed for current sense circuits in power electronic systems
- Pb-Free to meet RoHS requirements
- AEC-Q200 Qualified (only High Power Rating)
- Inherently Anti-Sulfur

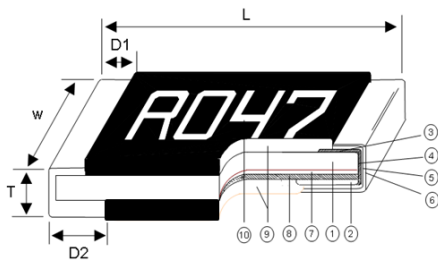
**■ Applications**

- Automotive (only High Power Rating)
- Power Management Applications
- Switching Power Supply
- Over Current Protection in Audio Applications
- Voltage Regulation Module (VRM)
- DC-DC Converter, Battery Pack, Charger, Adaptor

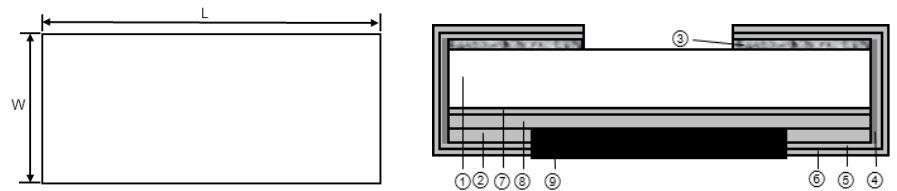


**■ Construction**

**For 0603 - 2512 Size**



**For 0402 Size**



①	Alumina Substrate	⑤	Barrier Layer	⑨	Primary Overcoat
②	Bottom Electrode	⑥	External Electrode	⑩	Marking
③	Top Electrode	⑦	Adhesive		
④	Edge Electrode	⑧	Resistor Layer		

**■ Dimensions**

**For Standard Series**

Type	Size (Inch)	Power (W)	Resistance Range (mΩ)	L	W	T	D1	D2	Weight (g) (1000pcs)
CSM03	0603	1/8	10 – 18	1.60±0.15	0.85±0.15	0.45±0.15	0.30±0.25	0.35±0.25	2.63
			19 – 100	1.60±0.15	0.85±0.15	0.40±0.15	0.30±0.25	0.35±0.25	2.53
CSM05	0805	1/4	10 – 18	2.05±0.15	1.25±0.15	0.60±0.15	0.30±0.25	0.35±0.25	6.24
			19 – 100	2.05±0.15	1.25±0.15	0.60±0.15	0.30±0.25	0.35±0.25	5.63
CSM06	1206	1/2	10 – 18	3.10±0.15	1.55±0.15	0.60±0.15	0.50±0.25	0.60±0.25	13.30
			19 – 100	3.10±0.15	1.55±0.15	0.60±0.15	0.50±0.25	0.60±0.25	11.63
CSM10	2010	3/4	10 – 18	5.00±0.20	2.50±0.20	0.60±0.15	0.60±0.30	0.80±0.30	31.42
			19 – 100	5.00±0.20	2.50±0.20	0.60±0.15	0.60±0.30	0.80±0.30	28.35
CSM12	2512	1	10 – 18	6.40±0.20	3.10±0.20	0.60±0.15	0.70±0.30	0.80±0.30	45.21
			19 – 100	6.40±0.20	3.10±0.20	0.60±0.15	0.70±0.30	0.80±0.30	43.49

**For High Power Series**

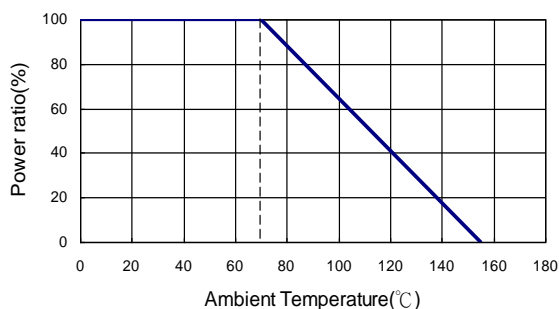
Type	Size (Inch)	Power (W)	Resistance Range (mΩ)	L	W	T	D1	D2	Weight (g) (1000pcs)
CSM02	0402	1/4	5 – 9	1.05±0.10	0.55±0.10	0.45±0.10	-	0.35±0.15	1.09
			10 – 18	1.05±0.10	0.55±0.10	0.45±0.10	-	0.30±0.15	1.11
			19 – 50	1.05±0.10	0.55±0.10	0.40±0.10	-	0.30±0.15	0.93
CSM03	0603	1/2	5 – 9	1.60±0.15	0.85±0.15	0.45±0.15	0.30±0.25	0.55±0.25	2.50
			10 – 18	1.60±0.15	0.85±0.15	0.45±0.15	0.30±0.25	0.35±0.25	2.63
			19 – 100	1.60±0.15	0.85±0.15	0.40±0.15	0.30±0.25	0.35±0.25	2.53
CSM05	0805	3/4	5 – 9	2.05±0.15	1.25±0.15	0.60±0.15	0.30±0.25	0.60±0.25	6.37
			10 – 18	2.05±0.15	1.25±0.15	0.60±0.15	0.30±0.25	0.35±0.25	6.24
			19 – 100	2.05±0.15	1.25±0.15	0.60±0.15	0.30±0.25	0.35±0.25	5.63
CSM06	1206	1	5 – 9	3.10±0.15	1.55±0.15	0.60±0.15	0.50±0.25	1.00±0.25	12.14
			10 – 18	3.10±0.15	1.55±0.15	0.60±0.15	0.50±0.25	0.60±0.25	13.30
			19 – 100	3.10±0.15	1.55±0.15	0.60±0.15	0.50±0.25	0.60±0.25	11.63
CSM10	2010	1.5	5 – 9	5.00±0.20	2.50±0.20	0.60±0.15	0.60±0.30	1.55±0.30	28.59
			10 – 18	5.00±0.20	2.50±0.20	0.60±0.15	0.60±0.30	0.80±0.30	31.42
			19 – 100	5.00±0.20	2.50±0.20	0.60±0.15	0.60±0.30	0.80±0.30	28.35
CSM12	2512	2	5 – 9	6.40±0.20	3.10±0.20	0.60±0.15	0.70±0.30	1.80±0.30	48.30
			10 – 18	6.40±0.20	3.10±0.20	0.60±0.15	0.70±0.30	0.80±0.30	45.21
			19 – 100	6.40±0.20	3.10±0.20	0.60±0.15	0.70±0.30	0.80±0.30	43.49

**Part Numbering**

CSM	06	F	T	E	U	R006	
Product Type	Dimensions (LxW)	Resistance Tolerance	Packaging Code	TCR (PPM/°C)	TCR (PPM/°C)	Resistance	Marking
	02: 0402 03: 0603 05: 0805 06: 1206 10: 2010 12: 2512	D: ±0.5% F: ±1% G: ±2% J: ±5%	T: Taping Reel	D: ±50 E: ±100 K: ±150 F: ±200 G: ±300	W : 1/8W V : 1/4W U: 1/2W Q: 3/4W T: 1W A: 1.5W S: 2W	R003: 0.003Ω R010: 0.01Ω R100: 0.1Ω	Marking for E96 / E24

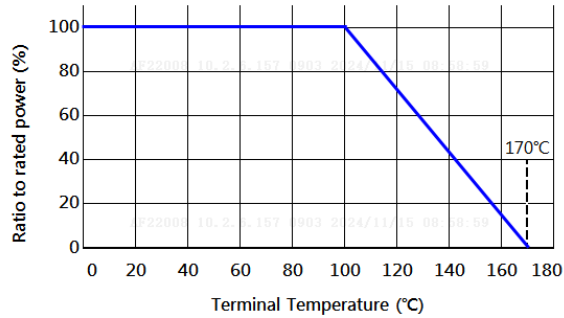
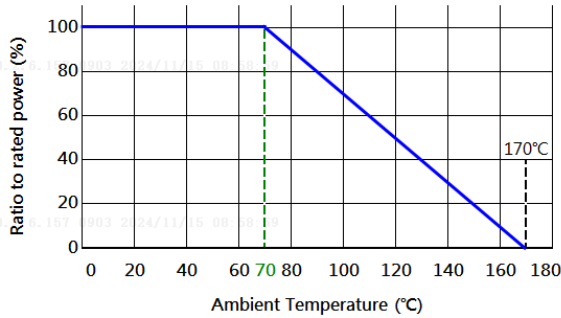
**Derating Curve**

**For Standard Series**



**Current Sensing Metal Chip Resistor**

**For High Power Series**



**Electrical Specifications**

**For Standard Series**

Item Type	Power Rating at 70°C	Operating Temp. Range	Resistance Range (mΩ)				TCR (PPM/°C)
			±0.5%	±1%	±2%	±5%	
CSM03 (0603)	1/8W	-55 ~ +155°C	-	10 - 19		±100	
			-	20 - 100		±50 ±100	
CSM05 (0805)	1/4W		-	10 - 19		±100	
			30 - 100	20 - 100		±50 ±100	
CSM06 (1206)	1/2W		-	10 - 19		±100	
			30 - 100	20 - 100		±50 ±100	
CSM10 (2010)	3/4W		-	10 - 19		±100	
			30 - 100	20 - 100		±50 ±100	
CSM12 (2512)	1W		-	10 - 19		±100	
			30 - 100	20 - 100		±50 ±100	

**For High Power Series**

Item Type	Power Rating at 70°C	Operating Temp. Range	Max. Overload Current	Resistance Range (mΩ)				TCR (PPM/°C)
				±0.5%	±1%	±2%	±5%	
CSM02 (0402)	1/4W	-55 ~ +170°C	15.8A	-	5 - 6		±300	
			13.4A	-	7 - 9		±200	
			11.2A	30 - 50	10 - 50		±100	
CSM03 (0603)	1/2W		22.7A	-	5 - 6		±150	
			18.9A	-	7 - 9		±100	
			15.8A	30 - 100	10 - 100		±100	
CSM05 (0805)	3/4W		27.4A	-	5 - 9		±100	
			19.4A	30 - 100	10 - 100		±50	
			CSM06 (1206)	1W	31.6A	-	5 - 9	
22.4A	30 - 100				10 - 100		±50	
CSM10 (2010)	1.5W	38.7A			-	5 - 9		±100
		27.4A	30 - 100	10 - 100		±50		
		CSM12 (2512)	2W	40.0A	-	5 - 9		±100
28.3A	30 - 100			10 - 100		±50		

Operating Voltage= $\sqrt{P \cdot R}$  ; Overload Voltage= $2.5 \cdot \sqrt{P \cdot R}$  ; Operating Current= $\sqrt{P/R}$

■ Viking is capable of manufacturing the optional spec based on customer's requirement.

**■ Environmental Characteristics**

**For Standard Series**

Item	Requirement	Test Method
Temperature Coefficient of Resistance (T.C.R.)	As Spec.	<b>JIS-C-5201-1 4.8</b> <b>IEC-60115-1 4.8</b> -55°C~+125°C, 25°C is the reference temperature
Short Time Overload	$\pm(0.5\%+0.05\Omega)$	<b>JIS-C-5201-1 4.13</b> <b>IEC-60115-1 4.13</b> 5 X Rated Power for 5 seconds 2512 size: 4* Rated Power for 5 seconds. Other size: 5* Rated Power for 5 seconds.
Insulation Resistance	$\geq 10G$	<b>JIS-C-5201-1 4.6</b> <b>IEC-60115-1 4.6</b> Max. Overload Voltage for 1 minute
Endurance	$\pm(1.0\%+0.05\Omega)$	<b>MIL-STD-202 Method 108A</b> 70 $\pm$ 2°C, RCWV for 1000 hrs with 1.5 hrs "ON" and 0.5 hrs "OFF"
Damp Heat with Load	$\pm(1.0\%+0.05\Omega)$	<b>JIS-C-5201-1 4.24</b> <b>IEC-60115-1 4.24</b> 40 $\pm$ 2°C, 90~95% R.H., RCWV for 1000 hrs with 1.5 hrs "ON" and 0.5 hr "OFF"
Dry Heat	$\pm(0.5\%+0.05\Omega)$	<b>JIS-C-5201-1 4.23</b> <b>IEC-60115-1 4.23.2</b> at +155 °C for 1000 hrs
Bending Strength	$\pm(1.0\%+0.05\Omega)$	<b>JIS-C-5201-1 4.33</b> Bending once for 60 seconds 2010, 2512 sizes: 2mm Other sizes: 3mm
Solderability	95% min. coverage	<b>JIS-C-5201-1 4.17</b> <b>IEC-60115-1 4.17</b> 245 $\pm$ 5°C for 3 seconds
Resistance to Soldering Heat	$\pm(0.5\%+0.05\Omega)$	<b>JIS-C-5201-1 4.18</b> <b>IEC-60115-1 4.18</b> 260 $\pm$ 5°C for 10 seconds
Voltage Proof	No breakdown or flashover	<b>JIS-C-5201-1 4.7</b> <b>IEC-60115-1 4.7</b> 1.42 times Max. Operating Voltage for 1 minute
Leaching	Individual leaching area $\leq 5\%$ Total leaching area $\leq 10\%$	<b>JIS-C-5201-1 4.18</b> <b>IEC-60068-2-58 8.2.1</b> 260 $\pm$ 5°C for 30 seconds
Rapid Change of Temperature	$\pm(0.5\%+0.05\Omega)$	<b>JIS-C-5201-1 4.19</b> <b>IEC-60115-1 4.19</b> -55°C to +155°C, 5 cycles

RCWV(Rated Continuous Working Voltage)= $\sqrt{P \cdot R}$  or Max. Operating Voltage whichever is lower.

■ **Storage Temperature: 15~28°C; Humidity < 80%RH**

■ **Shelf Life: 2 years from production date.**

**Environmental Characteristics**

**For High Power Series**

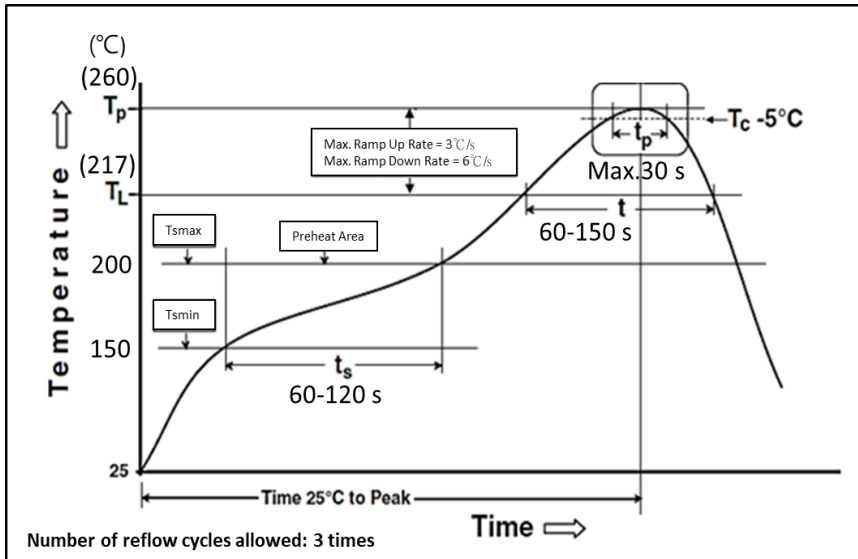
Item	Requirement	Test Method
Temperature Coefficient of Resistance (T.C.R.)	As Spec.	<b>JIS-C-5201-1 4.8</b> <b>IEC-60115-1 4.8</b> -55°C~+125°C, 25°C is the reference temperature
Short Time Overload	$\Delta R \leq \pm 1\%R$	<b>JIS-C-5201-1 4.13</b> <b>IEC-60115-1 4.13</b> 5 X Rated Power for 5 seconds 2512 size: 4* Rated Power for 5 seconds. Other size: 5* Rated Power for 5 seconds.
Insulation Resistance	$\geq 1000M\Omega$	<b>JIS-C-5201-1 4.6</b> <b>IEC-60115-1 4.6</b> Max. Overload Voltage for 1 minute
Operational Life	$\Delta R \leq \pm 1\%R$	<b>MIL-STD-202 Method 108</b> Condition D Steady State $T_A=125^\circ\text{C}$ at derated power. Measurement at $24 \pm 4$ hours after test conclusion
Biased Humidity	$\Delta R \leq \pm 1\%R$	<b>MIL-STD-202 Method 103</b> 85°C/85RH., 1000 hrs, apply 10% of operating power (current) or limiting element current whichever is lower
High Temperature Exposure	$\Delta R \leq \pm 1\%R$	<b>MIL-STD-202 Method 108</b> at +155°C for 1000 hrs
Temperature Cycling	$\Delta R \leq \pm 1\%R$	<b>JESD22 Method JA-104</b> -55°C to +125°C, 1000 cycles
Bending Strength (Board Flex)	$\Delta R \leq \pm 1\%R$	<b>JIS-C-5201-1 4.33</b> Bending once for 60 seconds 2010, 2512 sizes: 2mm Other sizes: 3mm
Solderability	95% min. coverage	<b>JIS-C-5201-1 4.17</b> <b>IEC-60115-1 4.17</b> 245±5°C for 3 seconds
Resistance to Soldering Heat	$\Delta R \leq \pm 1\%R$	<b>JIS-C-5201-1 4.18</b> <b>IEC-60115-1 4.18</b> 260±5°C for 10 seconds
Voltage Proof	No breakdown or flashover	<b>JIS-C-5201-1 4.7</b> <b>IEC-60115-1 4.7</b> 1.42 times Max. Operating Voltage for 1 minute
Resistance to solvents	Marking Unsmearred	<b>MIL-STD-202 Method 215</b> Add Aqueous wash chemical - OKEM Clean or equivalent. Do not use banned solvents.
Mechanical Shock	$\Delta R \leq \pm 1\%R$	<b>MIL-STD-202 Method 213</b> Wave Form: Tolerance for half sine shock pulse. Peak value is 100g's. Normal duration (D) is 6.
Vibration	$\Delta R \leq \pm 1\%R$	<b>MIL-STD-202 Method 204</b> 5 g's for 20 min., 12 cycles each of 3 orientations, 10-2000 Hz
ESD	$\Delta R \leq \pm 1\%R$	<b>AEC-Q200-002</b> <b>Human body model</b> 0402 sizes: 1KV Other sizes: 2KV
Flammability	No ignition of the tissue paper or scorching or the pinewood board	<b>UL-94</b> V-0 or V-1 are acceptable. Electrical test not required.
Terminal strength	No broken	<b>AEC-Q200-006</b> Force of 1.8kg for 60 seconds

RCWV(Rated Continuous Working Voltage)= $\sqrt{P \cdot R}$  or Max. Operating Voltage whichever is lower.

■ **Storage Temperature: 15~28°C; Humidity < 80%RH**

■ **Shelf Life: 2 years from production date.**

**■ Soldering Condition (IPC/JEDEC J-STD-020)**



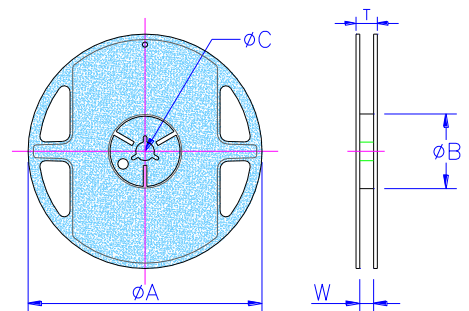
Reflow Profiles	
Profile Feature	Pb-Free Assembly
<b>Preheat</b> Min. Temperature (T <sub>smin</sub> ) Max Temperature (T <sub>smax</sub> ) Preheating time (t <sub>s</sub> ) from (T <sub>smin</sub> to T <sub>smax</sub> )	150 °C 200 °C 60-120 seconds
Ramp-up rate (T <sub>L</sub> to T <sub>p</sub> )	3 °C/second max.
Liquidous temperature (T <sub>L</sub> ) Time (t <sub>L</sub> ) maintained above T <sub>L</sub>	217 °C 60-150 seconds
Min. Peak temperature (T <sub>p</sub> min)	235°C
Max. Peak temperature (T <sub>p</sub> max)	260°C
Time (t <sub>p</sub> ) within 5 °C of the specified classification temperature (T <sub>c</sub> )	30 seconds max.
Ramp-down rate (T <sub>p</sub> to T <sub>L</sub> )	6 °C/second max.
Time 25 °C to peak temperature	8 minutes max.

**■ Packaging**

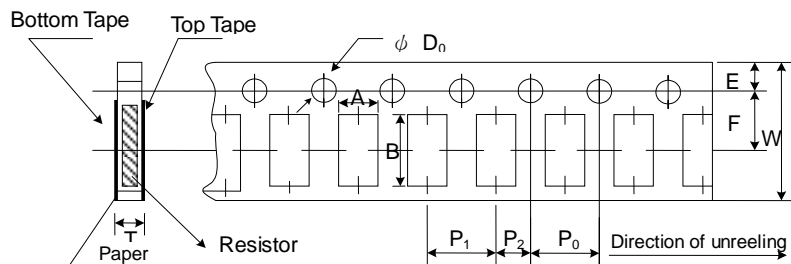
Packaging Quantity & Reel Specifications

Unit: mm

Type	ΦA	ΦB	ΦC	W	T	Paper Tape (EA)	Emboss Plastic Tape (EA)
CSM02	178.0±1.0	60.0+1.0	13.5±0.7	9.5±0.1	11.5±1.0	10,000	-
CSM03	178.0±1.0	60.0+1.0	13.5±0.7	9.5±0.1	11.5±1.0	5,000	-
CSM05	178.0±1.0	60.0+1.0	13.5±0.7	9.5±0.1	11.5±1.0	5,000	-
CSM06	178.0±1.0	60.0+1.0	13.5±0.7	9.5±0.1	11.5±1.0	5,000	-
CSM10	178.0±1.0	60.0+1.0	13.5±0.7	13.5±1.0	15.5±1.0	-	4,000
CSM12	178.0±1.0	60.0+1.0	13.5±0.7	13.5±1.0	15.5±1.0	-	4,000



Paper Tape Specifications

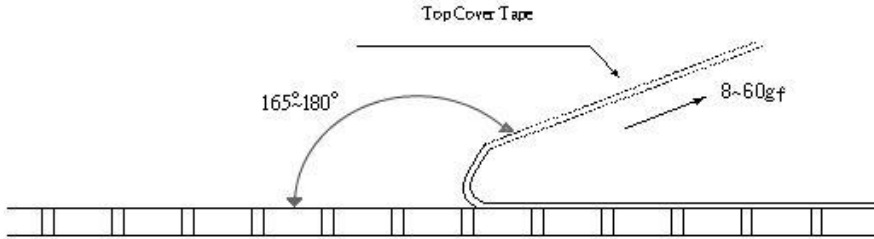


Unit: mm

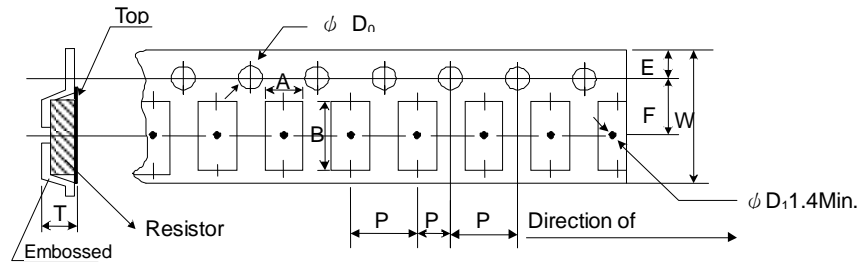
**Current Sensing Metal Chip Resistor**

Type	A	B	W	E	F	P <sub>0</sub>	P <sub>1</sub>	P <sub>2</sub>	ΦD <sub>0</sub>	T
CSM02	0.66±0.06	1.18±0.06	8.0±0.20	1.75±0.10	3.50±0.05	4.00±0.10	2.00±0.05	2.00±0.05	1.55±0.05	0.60±0.06
CSM03	1.10±0.10	1.85±0.10	8.0±0.20	1.75±0.10	3.50±0.05	4.00±0.10	4.00±0.05	2.00±0.05	1.50+0.1,-0	0.60±0.05
CSM05	1.60±0.10	2.35±0.20	8.0±0.20	1.75±0.10	3.50±0.05	4.00±0.10	4.00±0.05	2.00±0.05	1.50+0.1,-0	0.95±0.05
CSM06	1.90±0.10	3.50±0.20	8.0±0.20	1.75±0.10	3.50±0.05	4.00±0.10	4.00±0.05	2.00±0.05	1.50+0.1,-0	0.95±0.05

- Peel force of top cover tape
- The peel speed shall be about 300mm/min±5%
- The peel force of top cover tape shall be between 8gf to 60gf



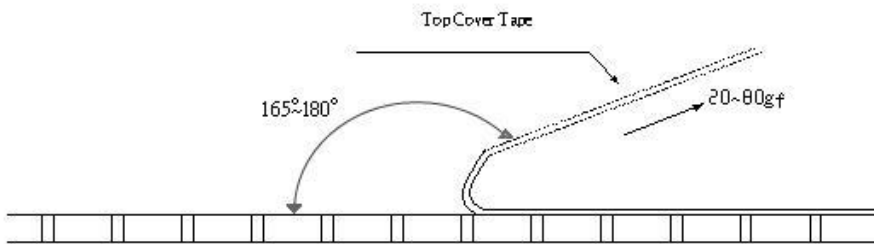
**Embossed Plastic Tape Specifications**



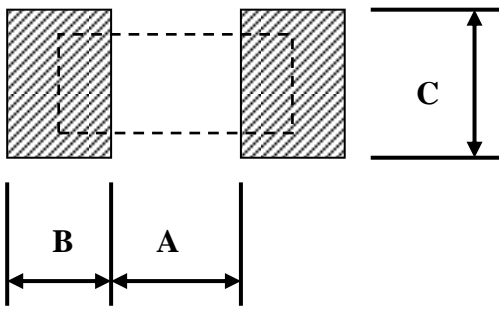
Unit: mm

Type	A	B	W	E	F	P <sub>0</sub>	P <sub>1</sub>	P <sub>2</sub>	ΦD <sub>0</sub>	T
CSM10	2.80±0.10	5.50±0.10	12.0±0.10	1.75±0.10	5.5±0.05	4.00±0.05	4.00±0.10	2.00±0.05	1.50+0.10	1.00±0.20
CSM12	3.50±0.10	6.70±0.10	12.0±0.10	1.75±0.10	5.5±0.05	4.00±0.05	4.00±0.10	2.00±0.05	1.50+0.10	1.00±0.20

- Peel force of top cover tape
- The peel speed shall be about 300mm/min±5%
- The peel force of top cover tape shall be between 20gf to 80gf



**Recommend Land Pattern**



Pad Layout

Type	Resistance Range	A (mm)	B (mm)	C (mm)	t (μm)
CSM02	5-50mΩ	0.50	0.50	0.60	35
CSM03	5-9mΩ	0.40	1.20	0.90	35
	10-100mΩ	0.70	1.05	0.90	35
CSM05	5-9mΩ	0.80	1.10	1.35	70
	10-100mΩ	1.00	1.00	1.35	70
CSM06	5-9mΩ	0.9	1.70	1.70	105
	10-100mΩ	1.50	1.40	1.70	105
CSM10	5-9mΩ	1.70	2.35	2.50	105
	10-100mΩ	2.80	1.80	2.50	105
CSM12	5-9mΩ	2.30	2.90	3.20	105
	10-100mΩ	3.60	2.25	3.20	105

t : copper foil minimum thickness of PCB

**Marking**

No Marking for 0402

**For 0603**

Type	Code
R10	0.100Ω
R01	0.010Ω
<u>035</u>	0.035Ω
<u>005</u>	0.005Ω

**For 0805-2512**

Type	Code
R100	0.100Ω
R050	0.050Ω
R010	0.010Ω
R005	0.005Ω